FDMS8670S Datasheet

https://www.DiGi-Electronics.com

DiGi Electronics Part Number	FDMS8670S-DG
Manufacturer	onsemi
Manufacturer Product Number	FDMS8670S
Description	MOSFET N-CH 30V 20A/42A 8PQFN
Detailed Description	N-Channel 30 V 20A (Ta), 42A (Tc) 2.5W (Ta), 78W (Tc) Surface Mount 8-PQFN (5x6)

Purchase and inquiry

Manufacturer Product Number:	FDMS8670S	Manufacturer:	onsemi
Series:	PowerTrench®, SyncFET™	Product Status:	Obsolete
FET Type:	N-Channel	Technology:	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	30 V	Current - Continuous Drain (Id) @ 25°C:	20A (Ta), 42A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	4.5V, 10V	Rds On (Max) @ Id, Vgs:	3.5mOhm @ 20A, 10V
Vgs(th) (Max) @ Id:	3V @ 1mA	Gate Charge (Qg) (Max) @ Vgs:	73 nC @ 10 V
Vgs (Max):	±20V	Input Capacitance (Ciss) (Max) @ Vds:	4000 pF @ 15 V
FET Feature:	-	Power Dissipation (Max):	2.5W (Ta), 78W (Tc)
Operating Temperature:	-55°C ~ 150°C (TJ)	Mounting Type:	Surface Mount
Supplier Device Package:	8-PQFN (5x6)	Package / Case:	8-PowerTDFN
Base Product Number:	FDMS86		

Environmental & Export classification

RoHS Status:	ROHS3 Compliant	Moisture Sensitivity Level (MSL):	1 (Unlimited)
REACH Status:	REACH Unaffected	ECCN:	EAR99
HTSUS:	8541.29.0095		

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October 2014

FDMS8670S
N-Channel PowerTrench® SyncFET™
30V, 42A, 3.5mΩ

Features

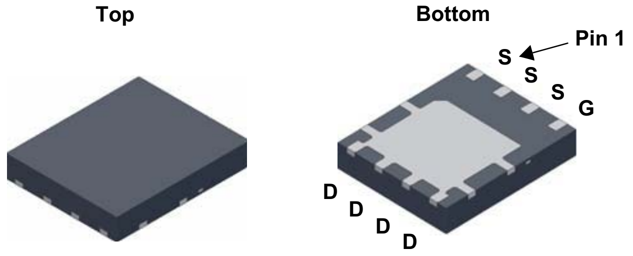
- Max $r_{DS(on)}$ = 3.5mΩ at V_{GS} = 10V, I_D = 20A
- Max $r_{DS(on)}$ = 5.0mΩ at V_{GS} = 4.5V, I_D = 17A
- Advanced Package and Silicon combination for low $r_{DS(on)}$ and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- RoHS Compliant

General Description

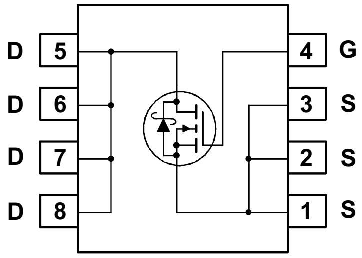
The FDMS8670S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Application

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



Power 56



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	30	V
V_{GS}	Gate to Source Voltage	±20	V
I_D	Drain Current -Continuous (Package limited) T_C = 25°C	42	A
	-Continuous (Silicon limited) T_C = 25°C	116	
	-Continuous (Silicon limited) T_C = 100°C	74	
	-Continuous T_A = 25°C	20	
	-Pulsed	200	
P_D	Power Dissipation T_C = 25°C	78	W
	Power Dissipation T_A = 25°C (Note 1a)	2.5	
	Power Dissipation T_A = 85°C (Note 1a)	1.3	
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8670S	FDMS8670S	Power 56	13”	12mm	3000 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units

Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 1mA, V_{GS} = 0V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 10mA, referenced to 25°C		17		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 24V, V_{GS} = 0V			500	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V			±100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 1mA	1	1.5	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 50mA, referenced to 25°C		-2.8		mV/°C
$r_{DS(on)}$	Drain to Source On Resistance	V_{GS} = 10V, I_D = 20A		2.8	3.5	mΩ
		V_{GS} = 4.5V, I_D = 17A		3.6	5.0	
		V_{GS} = 10V, I_D = 20A ,T_J = 125°C		3.9	6.0	
g_{FS}	Forward Transconductance	V_{DS} = 10V, I_D = 20A		98		S

Dynamic Characteristics

C_{iss}	Input Capacitance	V_{DS} = 15V, V_{GS} = 0V f = 1MHz		3005	4000	pF
C_{oss}	Output Capacitance			865	1150	pF
C_{rss}	Reverse Transfer Capacitance			320	480	pF
R_g	Gate Resistance	f = 1MHz		1.4	5.0	Ω

Switching Characteristics

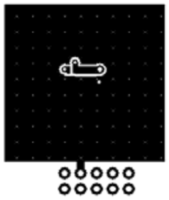
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 15V, I_D = 20A V_{GS} = 10V, R_{GEN} = 5Ω		14	26	ns
t_r	Rise Time			19	35	ns
$t_{d(off)}$	Turn-Off Delay Time			37	60	ns
t_f	Fall Time			10	20	ns
$Q_{g(TOT)}$	Total Gate Charge at 10V	V_{GS} = 0V to 10V V_{DS} = 15V I_D = 20A		52	73	nC
$Q_{g(4.5V)}$	Total Gate Charge at 4.5V	V_{GS} = 0V to 4.5V		24	34	nC
Q_{gs}	Gate to Source Gate Charge			8		nC
Q_{gd}	Gate to Drain "Miller" Charge			10		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0V, I_S = 2A		0.4	0.7	V
t_{rr}	Reverse Recovery Time	I_F = 20A, di/dt = 300A/μs		26	42	ns
Q_{rr}	Reverse Recovery Charge			24	39	nC

Notes:

1: $R_{\theta JA}$ is determined with the device mounted on a 1in^2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 50°C/W when mounted on a 1 in^2 pad of 2 oz copper

b. 125°C/W when mounted on a minimum pad of 2 oz copper

2: Pulse time < 300μs, Duty cycle < 2%.

Typical Characteristics T_J = 25°C unless otherwise noted

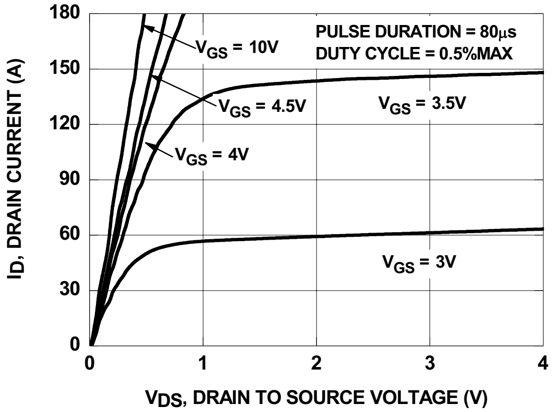


Figure 1. On Region Characteristics

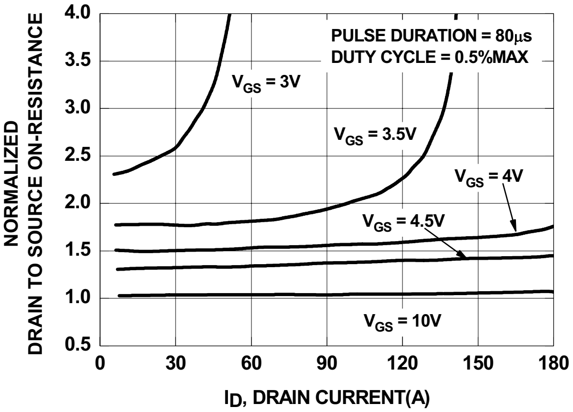


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

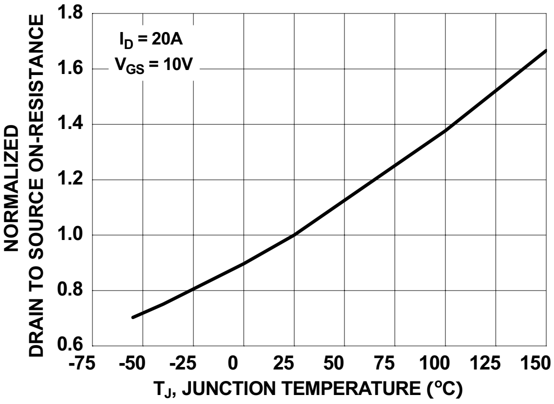


Figure 3. Normalized On Resistance vs Junction Temperature

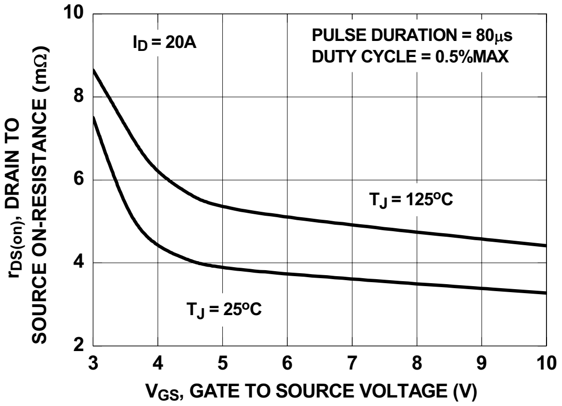


Figure 4. On-Resistance vs Gate to Source Voltage

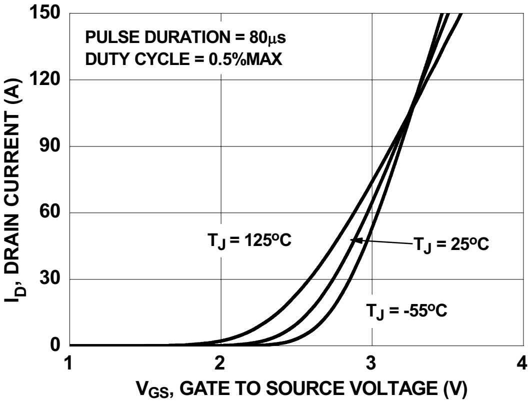


Figure 5. Transfer Characteristics

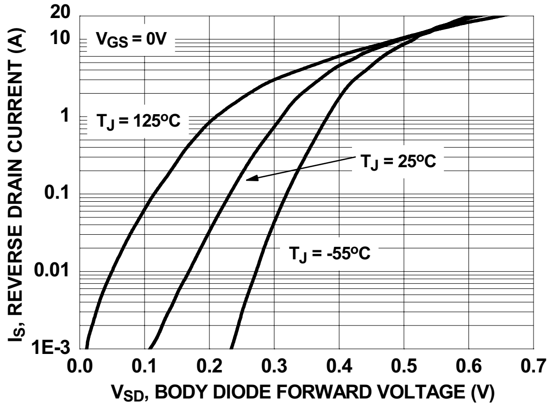


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25°C unless otherwise noted

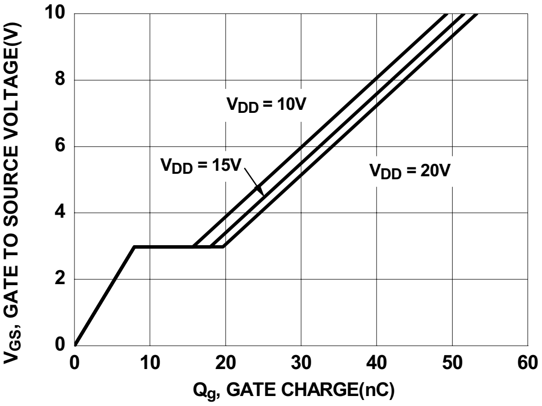


Figure 7. Gate Charge Characteristics

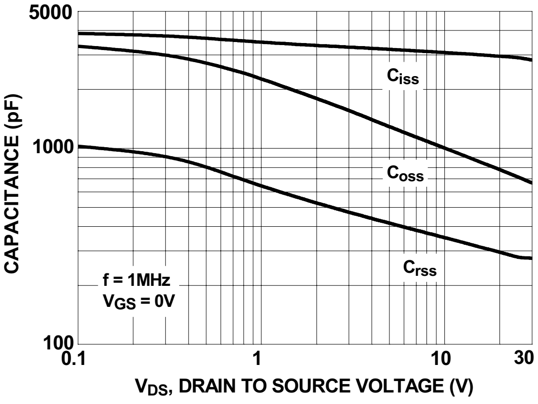


Figure 8. Capacitance vs Drain to Source Voltage

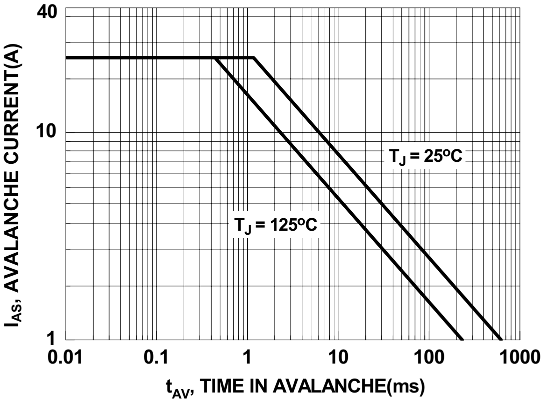


Figure 9. Unclamped Inductive Switching Capability

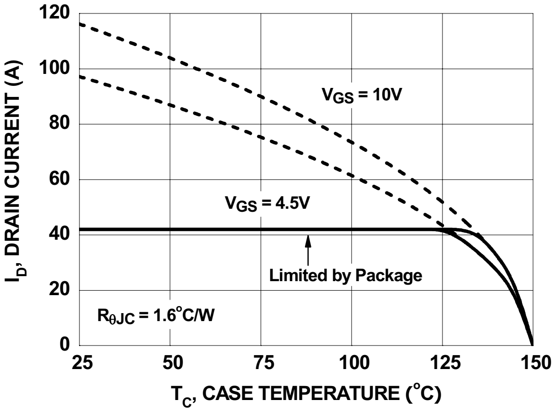


Figure 10. Maximum Continuous Drain Current vs Case Temperature

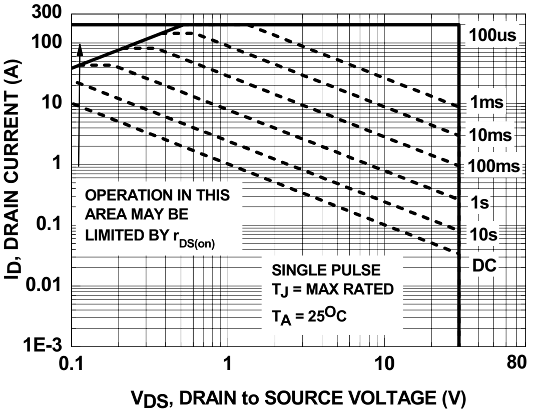


Figure 11. Forward Bias Safe Operating Area

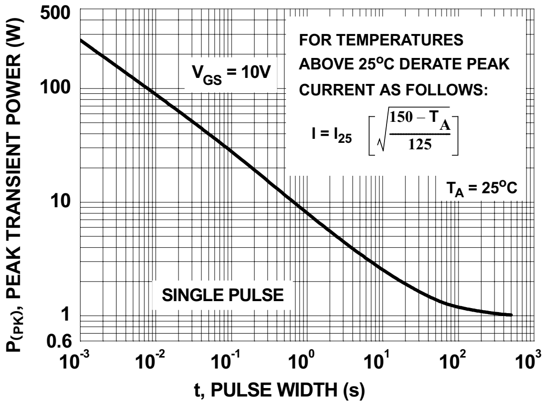


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics T_J = 25°C unless otherwise noted

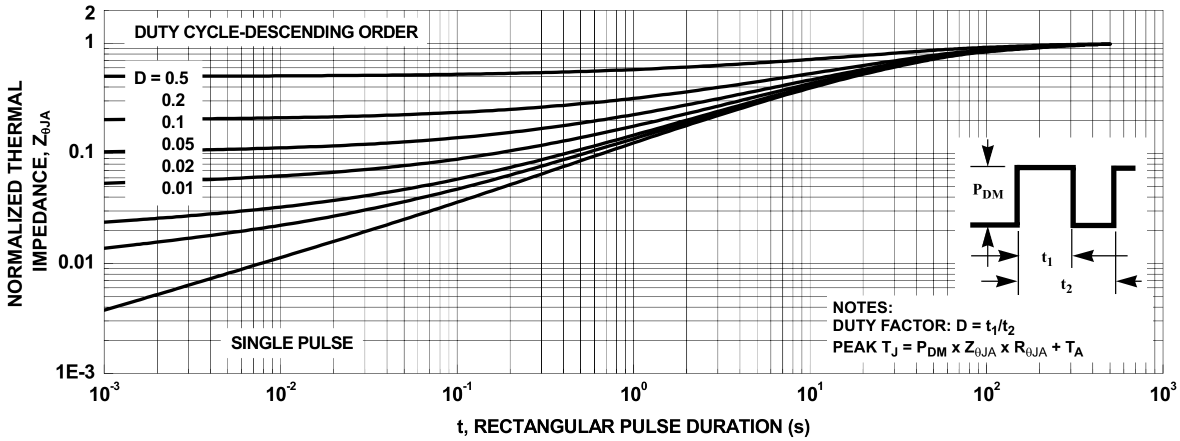


Figure 13. Transient Thermal Response Curve

Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS8670S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

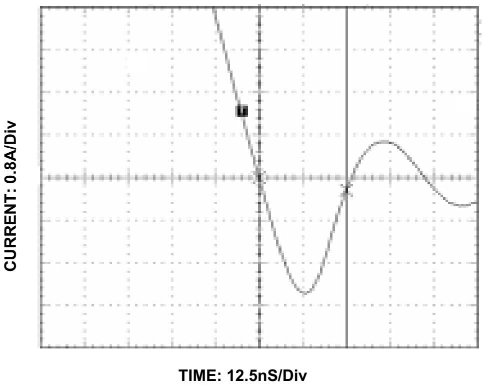


Figure 14. FDMS8670S SyncFET Body Diode reverse recovery characteristics

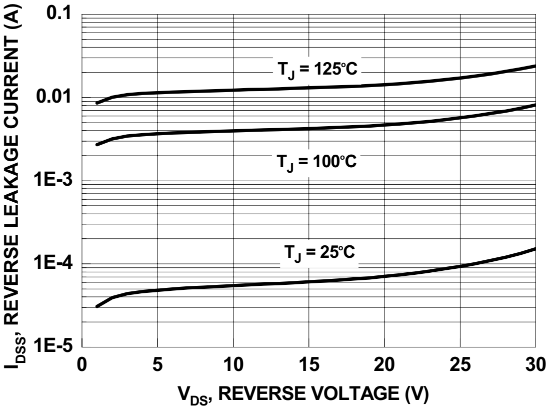
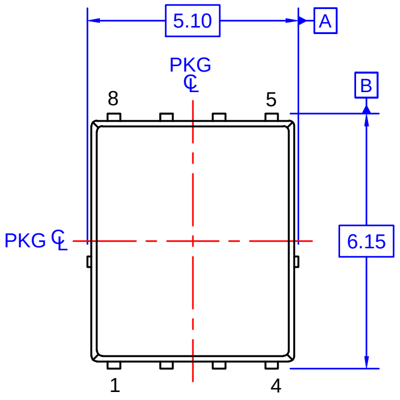
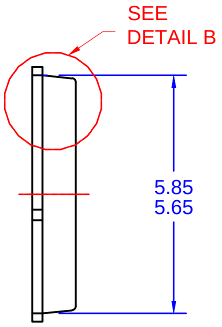


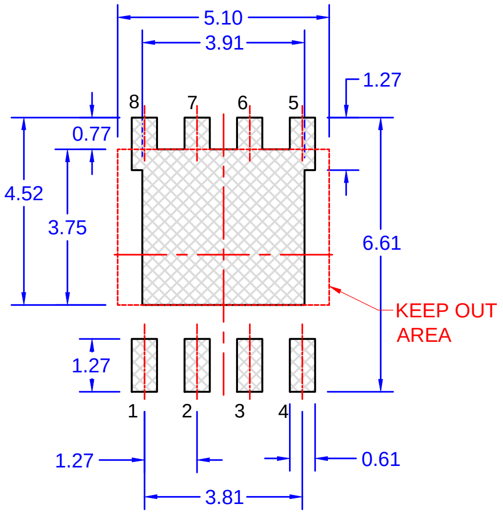
Figure 15. SyncFET Body Diode reverse leakage vs drain to source voltage

PQFN8 5X6, 1.27P
CASE 483AE
ISSUE A

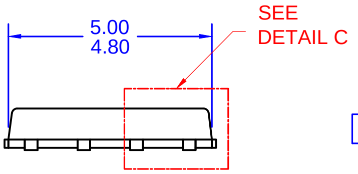


TOP VIEW

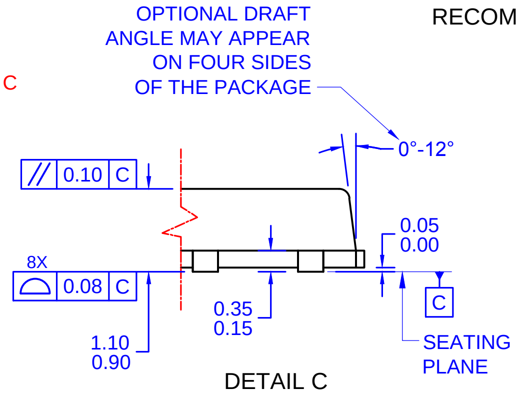




LAND PATTERN
RECOMMENDATION



SIDE VIEW



DETAIL C

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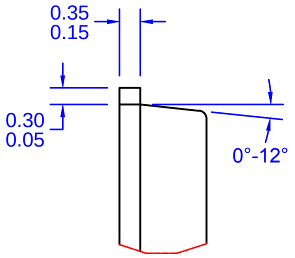
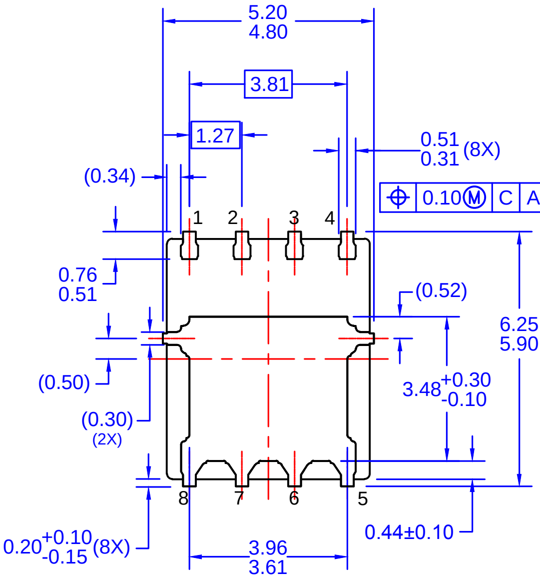


DETAIL B

SCALE: 2:1



BOTTOM VIEW

NOTES: UNLESS OTHERWISE SPECIFIED
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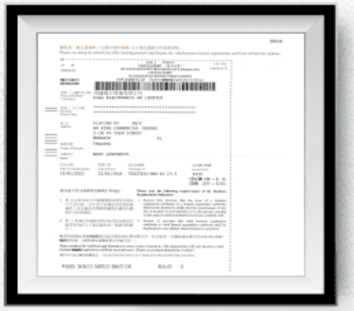

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